

## G2U09N70

### N-CHANNEL ENHANCEMENT MODE POWER MOSFET

BV <sub>DSS</sub>	600/650/700V
R <sub>DS(ON)</sub>	0.75Ω
I <sub>D</sub>	9A

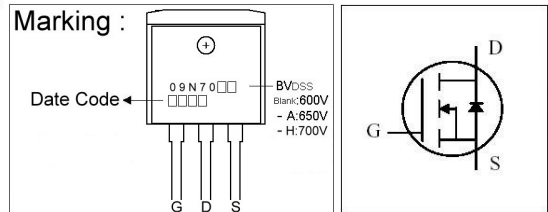
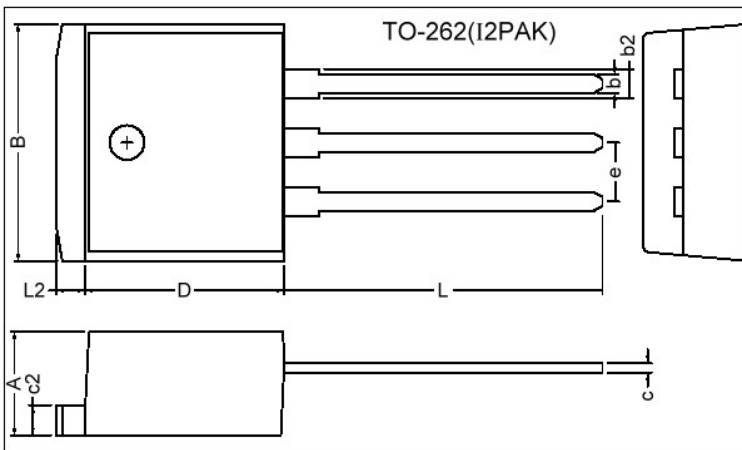
### Description

The G2U09N70 series are specially designed as main switching devices for universal 90~265VAC off-line AC/DC converter applications. TO-262 type provide high blocking voltage to overcome voltage surge and sag in the toughest power system with the best combination of fast switching, ruggedized design and cost-effectiveness. The TO-262 package is universally preferred for all commercial-industrial applications. The device is suited for switch mode power supplies, DC-AC converters and high current high speed switching circuits.

### Features

- \*Dynamic dv/dt Rating
- \*Simple Drive Requirement
- \*Repetitive Avalanche Rated
- \*Fast Switching Speed

### Package Dimensions



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.40	4.80	c2	1.25	1.45
b	0.76	1.00	b2	1.17	1.47
c	0.36	0.50	L	13.25	14.25
D	8.60	9.00	e	2.54 REF.	
E	9.80	10.4	L2	1.27 REF.	

### Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage - /A/H	V <sub>DS</sub>	600/650/700	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Continuous Drain Current, V <sub>GS</sub> @10V	I <sub>D</sub> @T <sub>C</sub> =25°C	9	A
Continuous Drain Current, V <sub>GS</sub> @10V	I <sub>D</sub> @T <sub>C</sub> =100°C	5	A
Pulsed Drain Current <sup>1</sup>	I <sub>DM</sub>	40	A
Total Power Dissipation	P <sub>D</sub> @T <sub>C</sub> =25°C	156	W
Linear Derating Factor		1.25	W/°C
Single Pulse Avalanche Energy <sup>2</sup>	E <sub>AS</sub>	305	mJ
Avalanche Current	I <sub>AR</sub>	9	A
Repetitive Avalanche Energy	E <sub>AR</sub>	9	mJ
Operating Junction and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150	°C

### Thermal Data

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-case Max.	R <sub>thj-c</sub>	0.8	°C/W
Thermal Resistance Junction-ambient Max.	R <sub>thj-a</sub>	62	°C/W

**Electrical Characteristics(T<sub>j</sub> = 25°C Unless otherwise specified)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	600	-	-	V	V <sub>GS</sub> =0, I <sub>D</sub> =250uA -
		650	-	-	V	V <sub>GS</sub> =0, I <sub>D</sub> =250uA A
		700	-	-	V	V <sub>GS</sub> =0, I <sub>D</sub> =250uA H
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS} / \Delta T_j$	-	0.6	-	V/°C	Reference to 25°C, I <sub>D</sub> =1mA
Gate Threshold Voltage	V <sub>GS(th)</sub>	2.0	-	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA
Forward Transconductance	g <sub>fs</sub>	-	4.5	-	S	V <sub>DS</sub> =50V, I <sub>D</sub> =4.5A
Gate-Source Leakage Current	I <sub>GSS</sub>	-	-	±1	uA	V <sub>GS</sub> = ±20V
Drain-Source Leakage Current(T <sub>j</sub> =25°C)	I <sub>DSS</sub>	-	-	100	uA	V <sub>DS</sub> =600V, V <sub>GS</sub> =0
Drain-Source Leakage Current(T <sub>j</sub> =150°C)		-	-	500	uA	V <sub>DS</sub> =480V, V <sub>GS</sub> =0
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	-	-	0.75	Ω	V <sub>GS</sub> =10V, I <sub>D</sub> =4.5A
Total Gate Charge <sup>3</sup>	Q <sub>g</sub>	-	44	-	nC	I <sub>D</sub> =9A V <sub>DS</sub> =480V V <sub>GS</sub> =10V
Gate-Source Charge	Q <sub>gs</sub>	-	11	-		
Gate-Drain ("Miller") Change	Q <sub>gd</sub>	-	12	-		
Turn-on Delay Time <sup>3</sup>	T <sub>d(on)</sub>	-	19	-	ns	V <sub>DD</sub> =300V I <sub>D</sub> =9A V <sub>GS</sub> =10V R <sub>G</sub> =10Ω R <sub>D</sub> =34Ω
Rise Time	T <sub>r</sub>	-	21	-		
Turn-off Delay Time	T <sub>d(off)</sub>	-	56	-		
Fall Time	T <sub>f</sub>	-	24	-		
Input Capacitance	C <sub>iss</sub>	-	2660	-	pF	V <sub>GS</sub> =0V V <sub>DS</sub> =25V f=1.0MHz
Output Capacitance	C <sub>oss</sub>	-	170	-		
Reverse Transfer Capacitance	C <sub>rss</sub>	-	10	-		

**Source-Drain Diode**

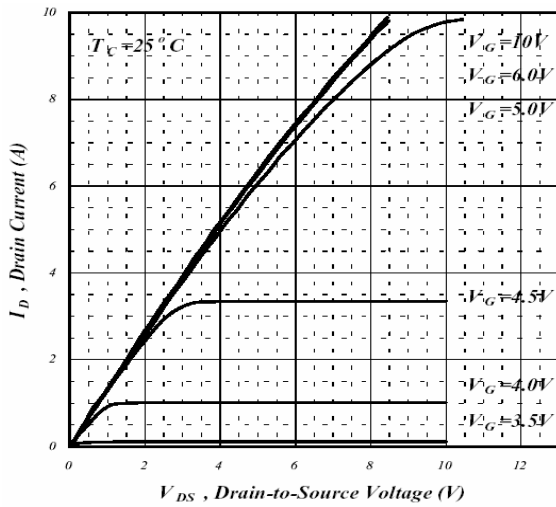
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Forward On Voltage <sup>3</sup>	V <sub>SD</sub>	-	-	1.5	V	I <sub>S</sub> =9A, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C
Continuous Source Current (Body Diode)	I <sub>S</sub>	-	-	9	A	V <sub>D</sub> = V <sub>G</sub> =0V, V <sub>S</sub> =1.5V
Pulsed Source Current (Body Diode) <sup>1</sup>	I <sub>SM</sub>	-	-	40	A	

Notes: 1. Pulse width limited by safe operating area.

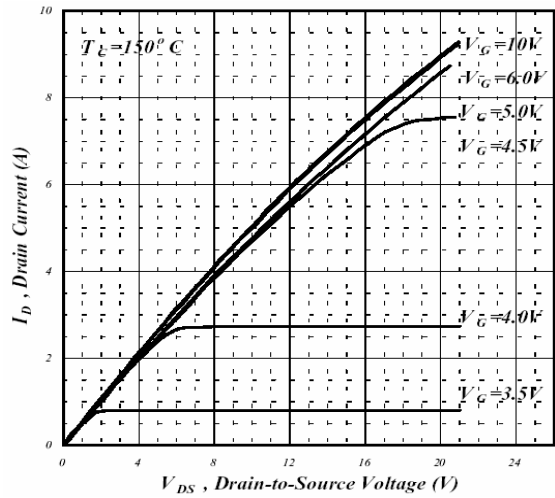
2. Staring T<sub>j</sub>=25°C, V<sub>DD</sub>=50V, L=6.8mH, R<sub>G</sub>=25Ω, I<sub>AS</sub>=9A.

3. Pulse width ≤ 300us, duty cycle ≤ 2%.

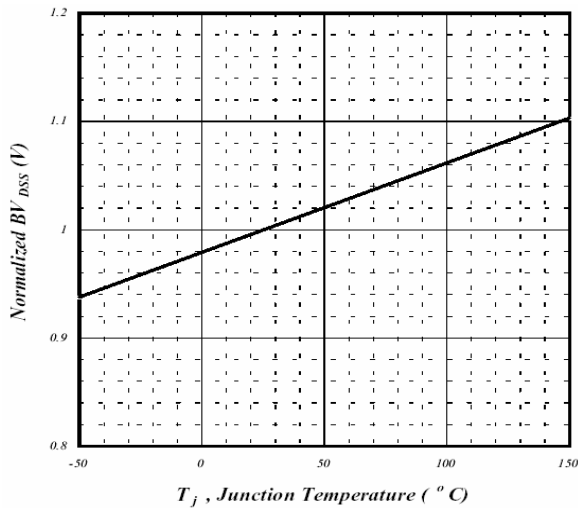
## Characteristics Curve



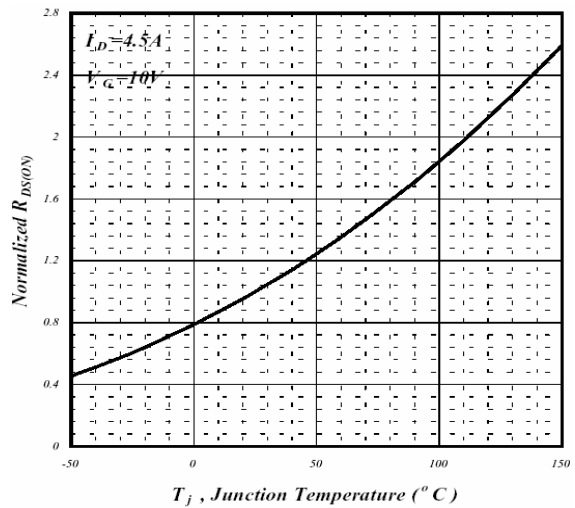
**Fig 1. Typical Output Characteristics**



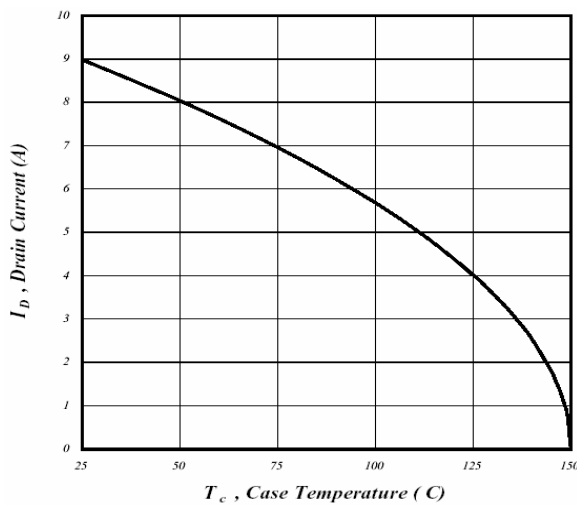
**Fig 2. Typical Output Characteristics**



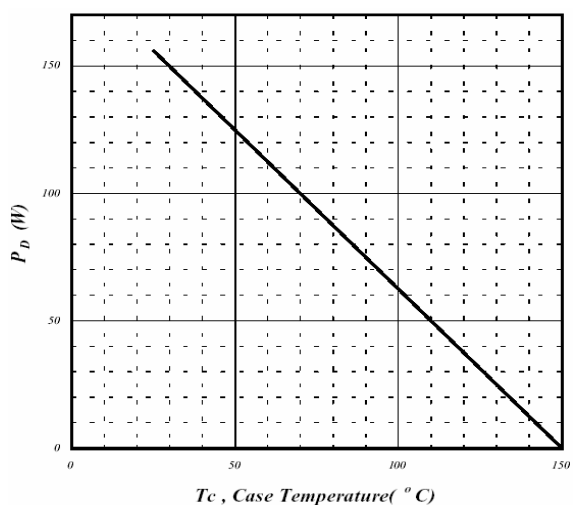
**Fig 3. Normalized  $BV_{DSS}$  v.s. Junction Temperature**



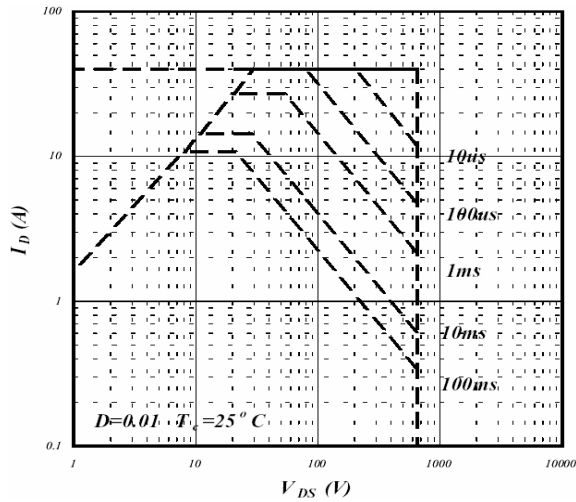
**Fig 4. Normalized On-Resistance v.s. Junction Temperature**



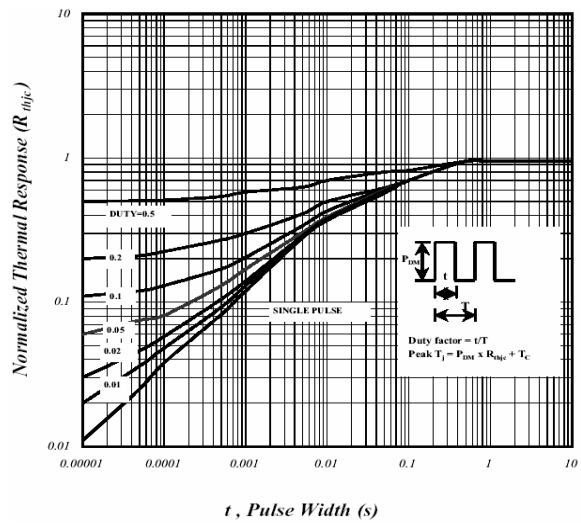
**Fig 5. Maximum Drain Current v.s. Case Temperature**



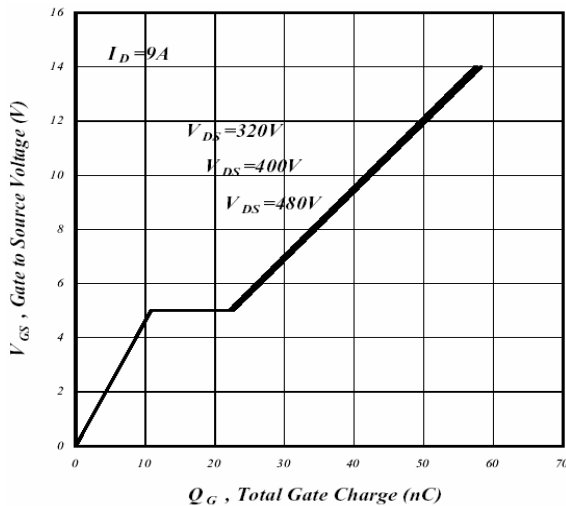
**Fig 6. Type Power Dissipation**



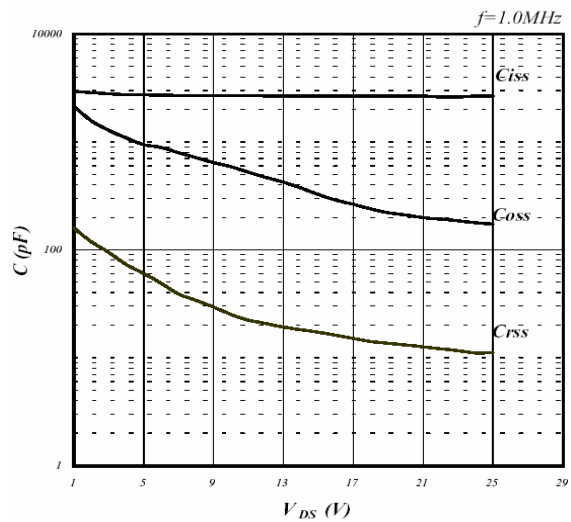
**Fig 7. Maximum Safe Operating Area**



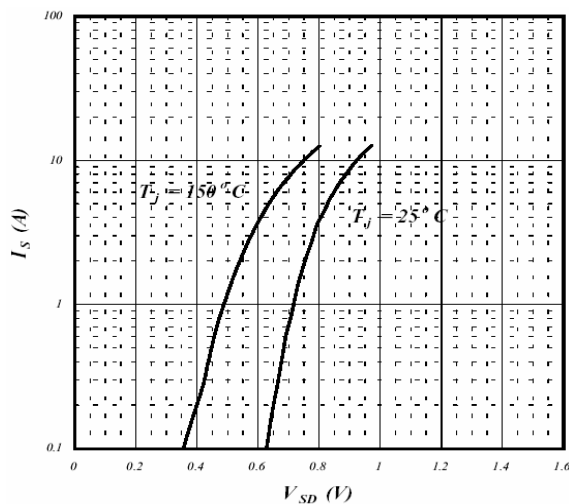
**Fig 8. Effective Transient Thermal Impedance**



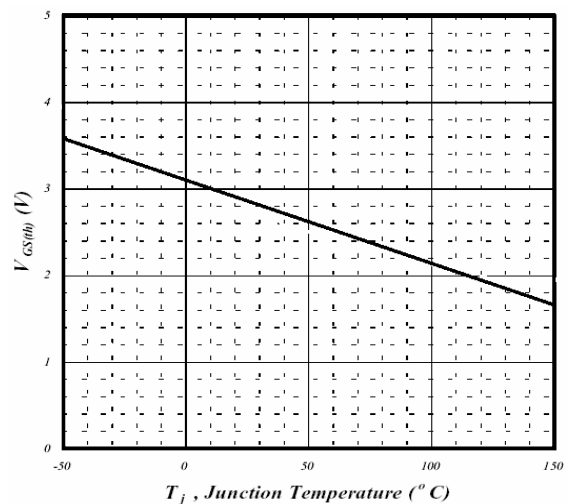
**Fig 9. Gate Charge Characteristics**



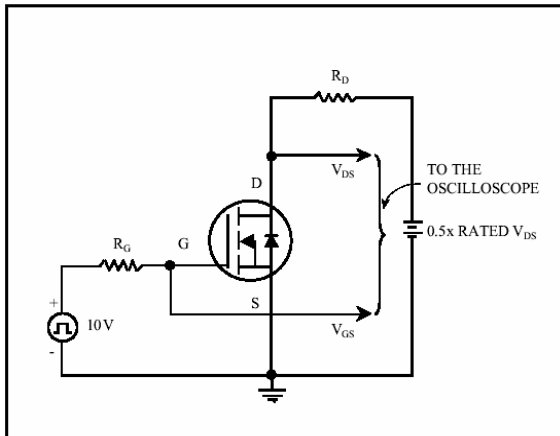
**Fig 10. Typical Capacitance Characteristics**



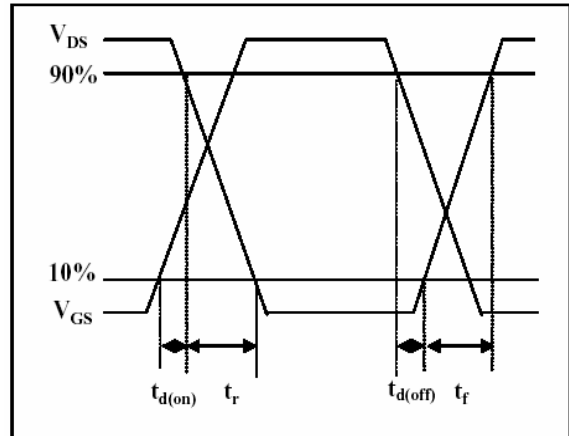
**Fig 11. Forward Characteristics of Reverse Diode**



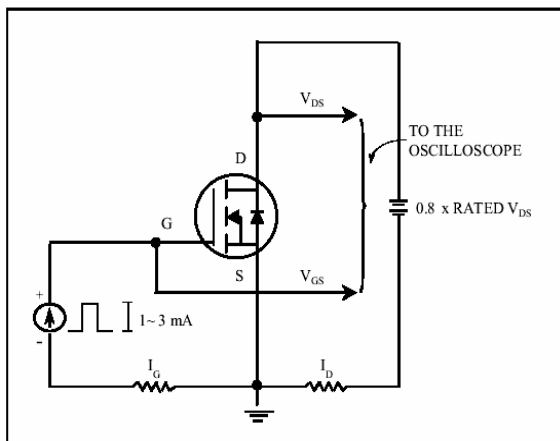
**Fig 12. Gate Threshold Voltage v.s. Junction Temperature**



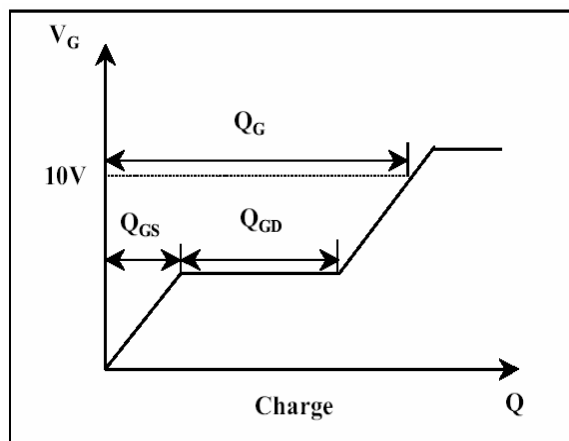
**Fig 13. Switching Time Circuit**



**Fig 14. Switching Time Waveform**



**Fig 15. Gate Charge Circuit**



**Fig 16. Gate Charge Waveform**

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**Head Office And Factory:**

- **Taiwan:** No. 17-1 Tatung Rd. Fu Kou Hsin-Chu Industrial Park, Hsin-Chu, Taiwan, R. O. C.
- TEL : 886-3-597-7061 FAX : 886-3-597-9220, 597-0785
- **China:** (201203) No.255, Jang-Jiang Tsai-Lueng RD. , Pu-Dung-Hsin District, Shang-Hai City, China
- TEL : 86-21-5895-7671 ~ 4 FAX : 86-21-38950165